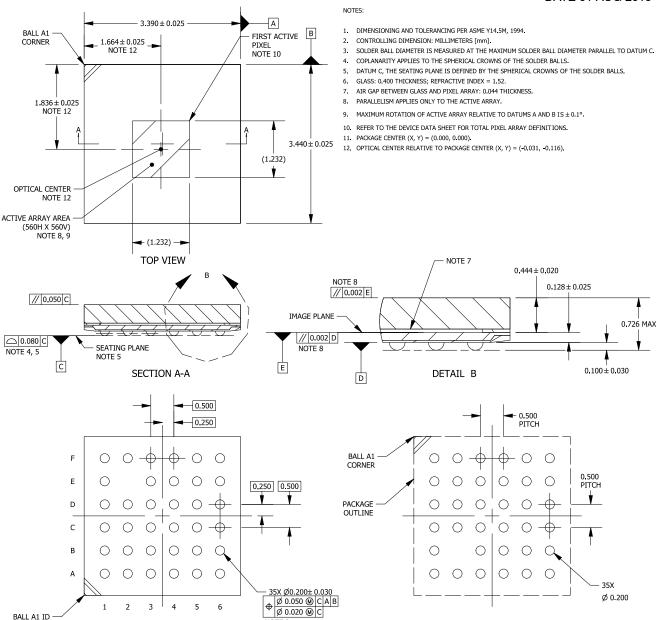
## ODCSP35 3.39x3.44 CASE 570CM **ISSUE A**

## **DATE 01 AUG 2019**



\*FOR ADDITIONAL INFORMATION ON OUR Ph-FRFF STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

RECOMENDED MOUNTING FOOTPRINT\*

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DESCRIPTION:	ODCSP35 3.39x3.44		PAGE 1 OF 1

NOTE 3

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**BOTTOM VIEW** 

BALL A1 ID